Tandem Insulated SOT-227 Power Module Hyperfast Rectifier, 60 A

SOT-227

FEATURES

- Two fully independent diodes
- Ceramic fully insulated package (V_{ISOL} = 2500 V_{AC})
- Hyperfast reverse recovery
- Optimized for power conversion: welding and industrial SMPS applications
- Industry standard outline
- Plug-in compatible with other SOT-227 packages
- Easy to assemble
- Direct mounting to heatsink
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level

RoHS COMPLIANT

PRODUCT SUMMARY	
V_R	600 V
$I_{F(AV)}$ per module at T_C = 126 °C	60 A
t_{rr}	39 ns

DESCRIPTION

The UFH60GA60P insulated modules integrate two state of the art Vishay hyperfast recovery rectifiers in the compact, industry standard SOT-227 package. The planar structure of the diodes, and the platinum doping life time control, provide an ultrasoft recovery current shape, together with the best overall performance, ruggedness, and reliability characteristics.

These devices are thus intended for high frequency applications in which the switching energy is designed not to be a predominant portion of the total energy, such as in the output rectification stage of welding machines, SMPS, and dc-to-dc converters. Their extremely optimized stored charge and low recovery current reduce both over dissipation in the switching elements (and snubbers) and EMI/RFI.

ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Cathode to anode voltage	V_R		600	V
Continuous forward current per diode	I_F	T_C = 85 °C	56	A
Single pulse forward current per diode	I_{FSM}	T_C = 25 °C	200	
Maximum power dissipation per module	P_D	T_C = 85 °C	230	W
RMS isolation voltage	V_{ISOL}	Any terminal to case, t = 1 min	2500	V
Operating junction and storage temperatures	T_J, T_{Stg}		- 55 to 175	°C

ELECTRICAL SPECIFICATIONS (T_J = 25 °C unless otherwise specified)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP.**	**MAX.**	**UNITS**
Cathode to anode breakdown voltage	V_{BR}	I_R = 100 µA		600	-	-	V
Forward voltage	V_{FM}	I_F = 30 A		-	2.08	3.8	
		I_F = 60 A		-	2.36	4.78	
		I_F = 30 A	T_J = 125 °C	-	1.79	1.92	
		I_F = 60 A		-	2.1	2.42	
Reverse leakage current	I_{RM}	V_R = V_R rated		-	0.03	75	µA
		T_J = 175 °C, V_R = V_R rated		-	0.1	1.0	mA
Junction capacitance	C_T	V_R = 600 V		-	33	-	pF

DYNAMIC RECOVERY CHARACTERISTICS (T_J = 25 °C unless otherwise specified)							
PARAMETER	**SYMBOL**	**TEST CONDITIONS**		**MIN.**	**TYP.**	**MAX.**	**UNITS**
Reverse recovery time	t_{rr}	T_J = 25 °C	I_F = 30 A dI_F/dt = 200 A/µs V_R = 200 V	-	39	80	ns
		T_J = 125 °C		-	66	110	
Peak recovery current	I_{RRM}	T_J = 25 °C		-	3	7	A
		T_J = 125 °C		-	7	11	
Reverse recovery charge	Q_{rr}	T_J = 25 °C		-	58	280	nC
		T_J = 125 °C		-	235	605	

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	**SYMBOL**	**TEST CONDITIONS**	**MIN.**	**TYP.**	**MAX.**	**UNITS**
Junction to case, single leg conducting	R_{thJC}		-	-	0.78	°C/W
Junction to case, both leg conducting			-	-	0.39	
Case to heatsink per module	R_{thCS}	Flat, greased surface	-	0.05	-	
Weight			-	30	-	g
Mounting torque			-	1.3	-	N · m

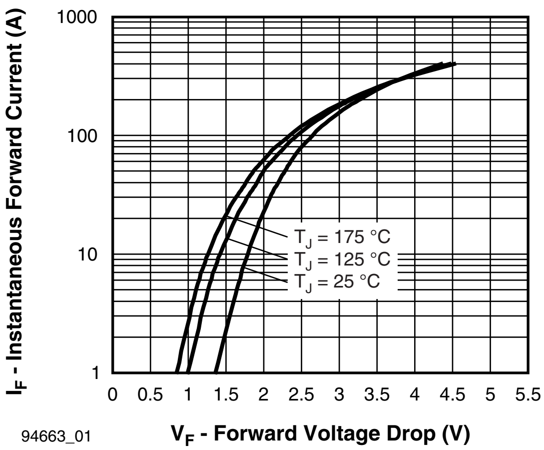


Fig. 1 - Typical Forward Voltage Drop Characteristics (Per Diode)

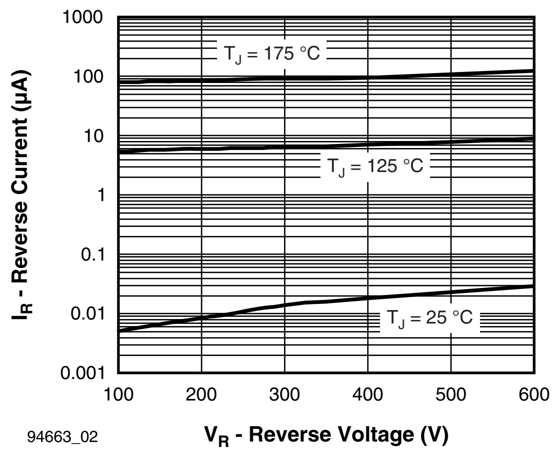


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

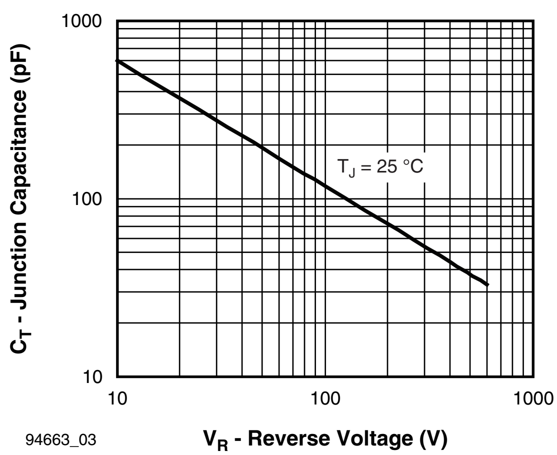


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

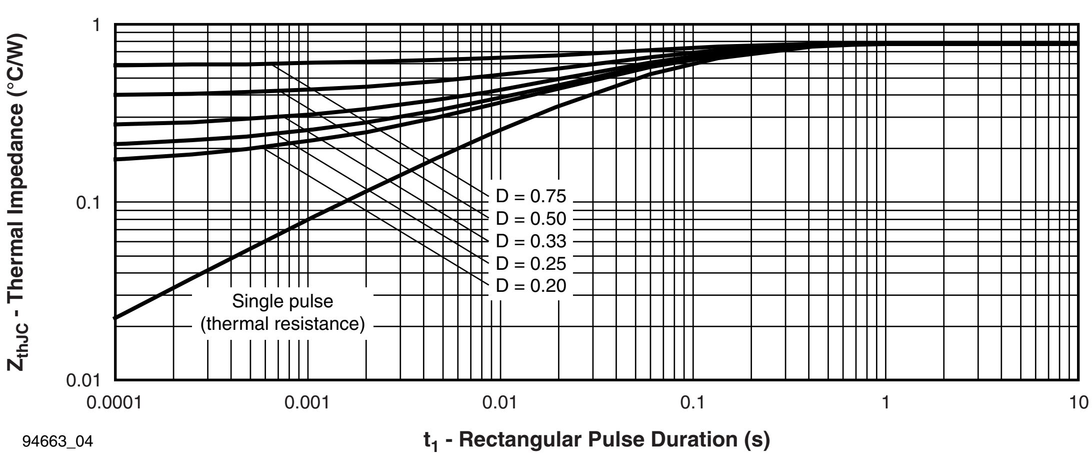


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics (Per Diode)

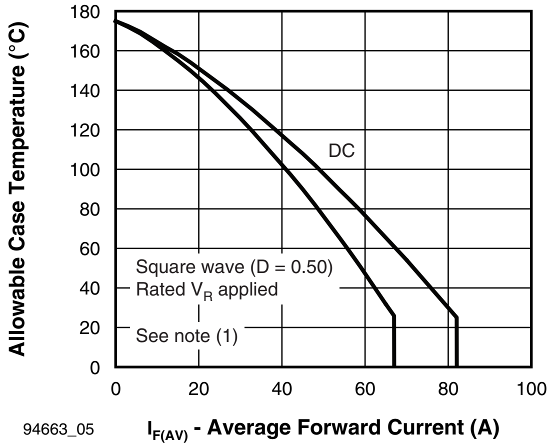


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

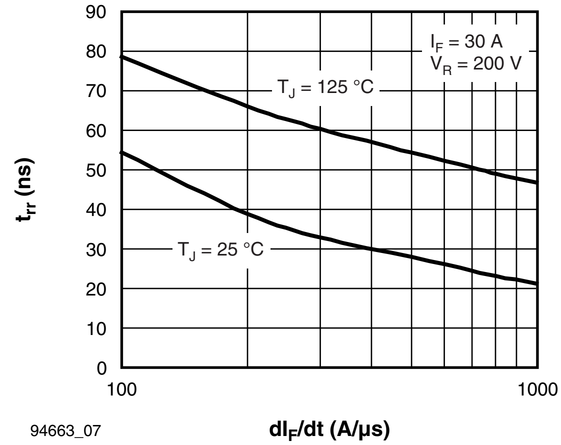


Fig. 7 - Typical Reverse Recovery Time vs. dI_F/dt

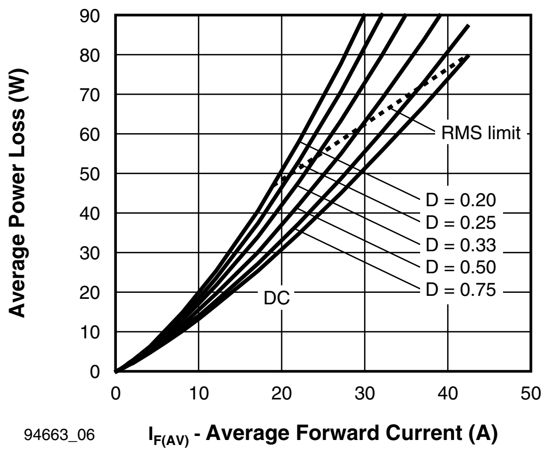


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

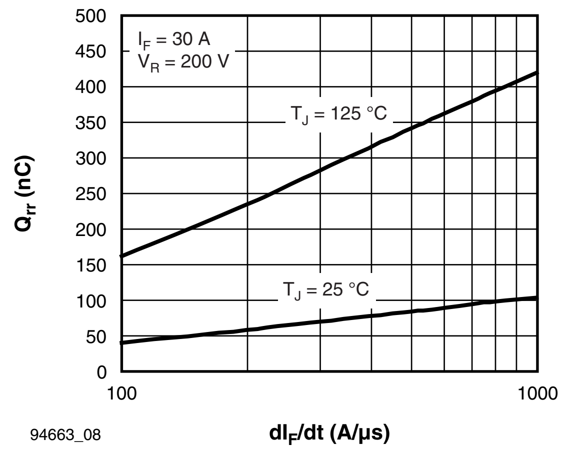


Fig. 8 - Typical Stored Charge vs. dI_F/dt

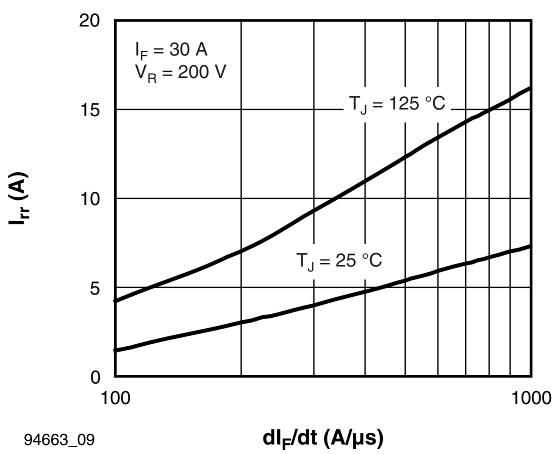


Fig. 9 - Typical Stored Current vs. dI_F/dt

Note

(1) Formula used: $T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}$;
Pd = Forward power loss = $I_{F(AV)} \times V_{FM}$ at $(I_{F(AV)}/D)$ (see fig. 6);
Pd_{REV} = Inverse power loss = $V_{R1} \times I_R (1 - D)$; I_R at V_{R1} = 80 % rated V_R

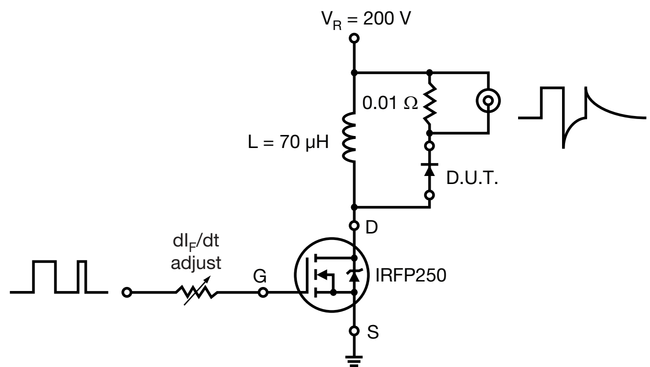
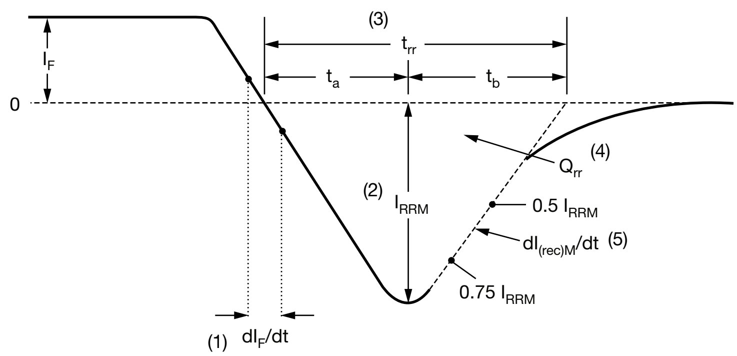


Fig. 10 - Reverse Recovery Parameter Test Circuit



(1) dI_F/dt - rate of change of current through zero crossing

(2) I_{RRM} - peak reverse recovery current

(3) t_{rr} - reverse recovery time measured from zero crossing point of negative going I_F to point where a line passing through 0.75 I_{RRM} and 0.50 I_{RRM} extrapolated to zero current.

(4) Q_{rr} - area under curve defined by t_{rr} and I_{RRM}

$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) $dI_{(rec)M}/dt$ - peak rate of change of current during t_b portion of t_{rr}

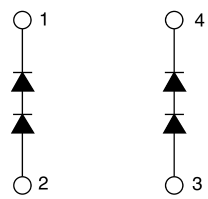
Fig. 11 - Reverse Recovery Waveform and Definitions

ORDERING INFORMATION TABLE

Device code	UF	H	60	G	A	60	P
	1	2	3	4	5	6	7

1 - Ultrafast rectifier
2 - Hyperfast rectifier
3 - Current rating (60 = 60 A)
4 - Circuit configuration (2 separate diodes, tandem configuration)
5 - Package indicator (SOT-227 standard isolated base)
6 - Voltage rating (60 = 600 V)
7 - P = Lead (Pb)-free

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS	
Dimensions	www.vishay.com/doc?95036
Packaging information	www.vishay.com/doc?95037

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